

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

LA0152CS

Monolithic Linear IC For Ultra-small illumination Sensor Photo IC

Overview

The LA0152CS is a photo IC for micro-sized illumination sensor which has the characteristics of spectral response similar to that of human eyes. It is suitable for applications like mobile phone, laptop computer, PDA, DSC and Camcorder.

Characteristic

- Smallest OD-CSP package in the world (1.01mm x 1.01mm x thickness: 0.6mm)
- Low variation and Optical Output Current in low temperature fluctuation.
- Integrated Sleep function.
- Low current consumption.

Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V _{CC}		6	V
Operating temperature	Topr		-30 to +85	°C
Storage temperature	Tstg		-40 to +100	°C

Recommended operating conditions and operating voltage range at Ta = 25°C

Parameter	Symbol	Conditions	Ratings			I India
			min	typ	max	Unit
SW pin low voltage	VI	Sleep mode	0		0.4	V
SW pin high voltage	Vh	Active mode	1.4		Vcc	V

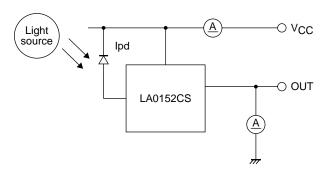
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Electrical and optical characteristics at Ta = 25°C, $V_{CC} = 3.3V$

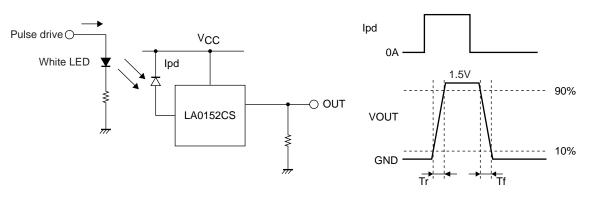
Parameter	Cumbal	Symbol Conditions		Ratings		
	Symbol		min	typ	max	Unit
Recommended Supply Voltage	VCC		2.2	3.3	5.5	V
Current dissipation *1, *3	Icc	Ev = 1000 lux, $R_L = 5k\Omega$	90	150	210	μΑ
Sleep Current(1) *3	I _{SL} 1	Ev= 0 lux			0.1	μΑ
Sleep Current(1) *3	I _{SL} 2	Ev= 1000 lux			0.3	μА
Output current (2) *1, *3	I _O 1	Ev = 100 lx	6	8	10	μА
Output current (2) *1, *3	I _O 2	Ev = 1000 lx	60	80	100	μΑ
Dark current *3	lleak	Ev = 0 lx			0.1	μА
Temperature coefficient *2	Itc	Ev = 100 lx		0.34		%/°C
Rise time *4	Tr	Ev = 1000 lx, $R_L = 5k\Omega$		15	40	μS
Fall time *4	Tf	Ev = 1000 lx, $R_L = 5kΩ$		150	500	μS
Peak sensitivity wave length *2	λр			550		nm
Saturation output voltage *1, *3	v _O	Ev = 1000 lx, $R_L = 150$ kΩ	3.0	3.2		V

^{*1.} Measured with the standard light source A. White LED is used instead in the mass production line.

^{*3.} Test circuit for measuring current dissipation and output current



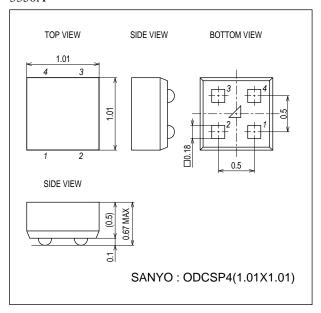
*4. Measuring method of rise time (Tr) and fall time (Tf)



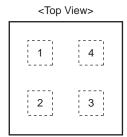
^{*2.} Design guaranteed item

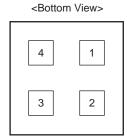
Package Dimensions

unit : mm (typ) 3350A



Pad layout

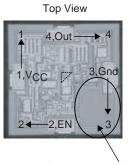


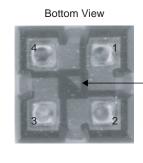


Pin No.	Pin Name	Function
1	Vcc	Power supply
2	EN	Enable
3	GND	Ground
4	OUT	Output

Ball pitch : 0.5mm, Ball size : 0.18mm[□]

Pad layout (Photos)



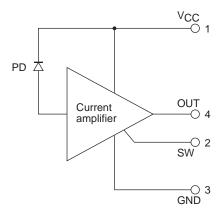


Pin 1 mark
It is located at the center of the bottom of the pakage.

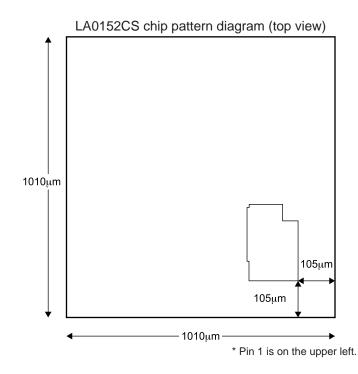
Photo diode. Only this part looks dark on the product.

* The photo diode is located in pin 3. Be careful not to mistake the pin 1 mark for the photo diode.

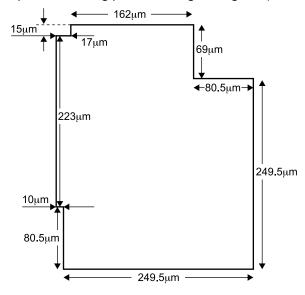
Internal block diagram

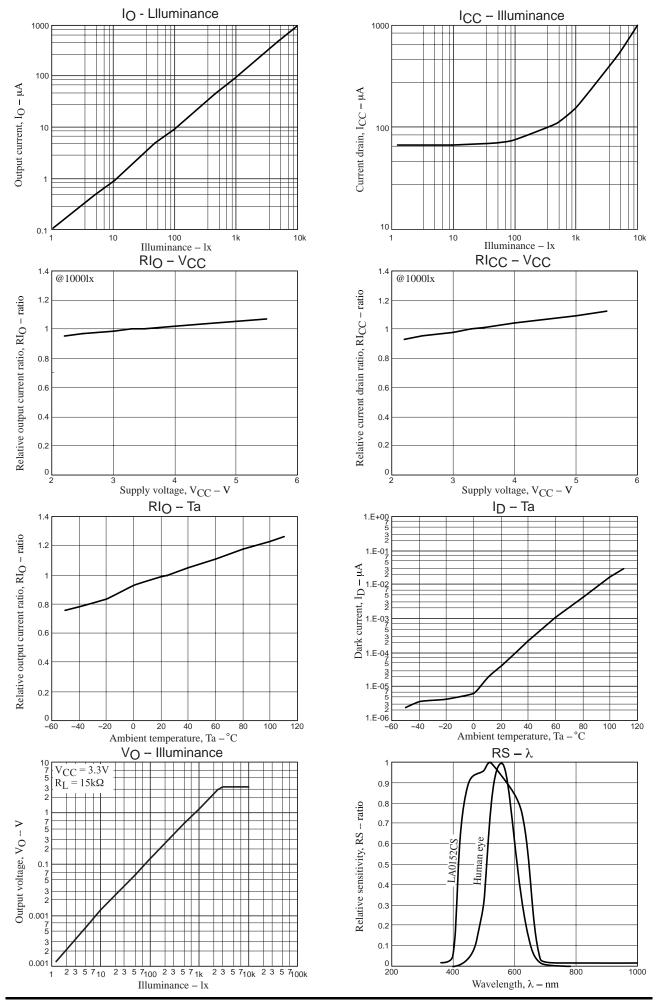


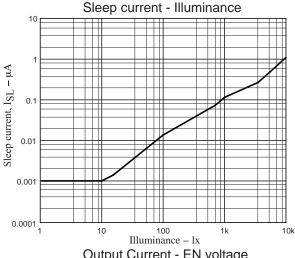
Chip pattern and photo-receiving pattern diagrams

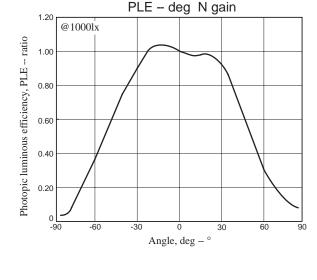


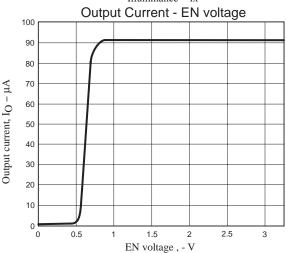
LA0152CS photo-receiving pattern enlarged diagram (effective area)











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